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23494 7590 12/28/2005

**W. DANIEL SWAYZE, JR.**  
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PO BOX 655474, M/S 3999  
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Shannon Trotter	(Depositor's name)
<i>Shannon Trotter</i>	(Signature)
3/13/06	(Date)

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/612,129	7/2/2003	Chee K. Yew	TI-26239.1	3928

**TITLE OF INVENTION:** DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC SUBSTRATE

APPLN. TYPE	SMALL ENTITY	ISSUE FEE	PUBLICATION FEE	TOTAL FEE(S) DUE	DATE DUE
nonprovisional	NO	\$1400	\$300	\$1700	03/28/2006

EXAMINER	ART UNIT	CLASS-SUBCLASS
Cao, Phat X.	2814	257-668000

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1 W. Daniel Swayze, Jr.

2 W. James Brady

3 Frederick J. Telecky, Jr.

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*3-13-2006*

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Total Pages Sent: 2

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

First Inventor: Yew

Docket Number: TI-26239.1

Serial No.: 10/612,129

Art Unit: 2814

Filed: 7/2/2003

Examiner: Cao, Phat X.

For: DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC SUBSTRATE

### CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at 571-273-2885 on the date shown below:

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NAME OF INVENTOR(S): Yew	
TITLE OF INVENTION: DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC SUBSTRATE	
TI FILE NO.:	DEPOSIT ACCT. NO.:
TI-26239.1	20-0668
FAXED: 3/13/06	
DUE: 3/18/2006	
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